

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

PATENT

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In re Application of:	LUNDSTROM, Dennis <i>et al.</i>	Group Art Unit:	1725
Serial No.:	10/707,185	Confirmation No.	1184
Date Filed:	November 25, 2003	Examiner:	JOHNSON, Jonathan J.
For:	METHOD OF TYING TWO OR MORE COMPONENTS TOGETHER		

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

INFORMATION DISCLOSURE STATEMENT

Dear Sir:

In compliance with Rules 1.97 and 1.98, it is respectfully requested that the references listed on the accompanying enclosed Form SB/08a be made of record and considered with respect to the above-referenced U.S. patent application. A copy of each reference is enclosed.

Referring to US Patents Cite No. 1, US 5,116,691, the state-of-the-art character of intermetallic compounds (intermetallics) is described at column 1, lines 35-48 as follows:

Intermetallic compounds, frequently referred to simply as intermetallics, are compounds of metals having particular crystal structures which are different from those of the component metals. Intermetallics have ordered atom distribution. Although the bonding of intermetallics is still predominantly metallic bonding, making them less brittle than ceramics, they still tend to be brittle at ambient temperature. These ordered structures exist over specific composition ranges and exhibit high melting points while having the potential for good strength, despite having low ductilities or fracture toughnesses at ambient temperature. Typical intermetallics include TiAl, Ti₃Al, Ni₃Al and NiAl.

Referring to Non-Patent Literature Cite No. 1, ORDERED INTERMETALLICS, certain basically accepted characteristics of intermetallics are defined in the Introduction section that reads:

ORDERED INTERMETALLICS

Introduction

For the past 15 years, considerable effort has been devoted to the study of ordered intermetallics, a unique class of metallic materials that form long-range ordered crystal structures below a critical temperature in the solid state. Some of these ordered intermetallics, especially those based on aluminides and silicides, possess many attractive properties for structural use at elevated temperatures in hostile environments (1-13). In general, the aluminides and silicides contain sufficient amounts of aluminum and

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silicon to form, in oxidizing environments, oxide scales that are often compact and protective. These intermetallics have relatively low density, high melting points, good thermal conductivity, and superb high-temperature strength. Many intermetallics also show a yield strength anomaly (14-16), that is, their strength increases rather than decreases with temperature. As a result, these intermetallics are particularly suited for structural applications at elevated temperatures.

Still further, the unique and well understood special characteristics of intermetallics are further described in Non-Patent Literature Cite No. 2, INTERMETALLIC PHASES - MATERIALS DEVELOPMENTS AND PROSPECTS, where the following is explained:

1 Introduction

Since several years there is a renewed and pronounced interest in intermetallic phases with respect to materials developments for high-temperature applications. These phases are compounds of metals with semimetals or non-metals which are different from those of the components. These structures form because there is a very strong bonding of the unlike atoms, and from this strong bonding particular physical and mechanical properties result. Intermetallic phases had been in use for various purposes since many centuries because of their comparatively high hardness (Table 1a), whereas in modern times their particular physical properties have been of primary interest (Table 1b).

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view. The processing of the high-strength intermetallics is difficult because of their brittleness, and thus the develop-

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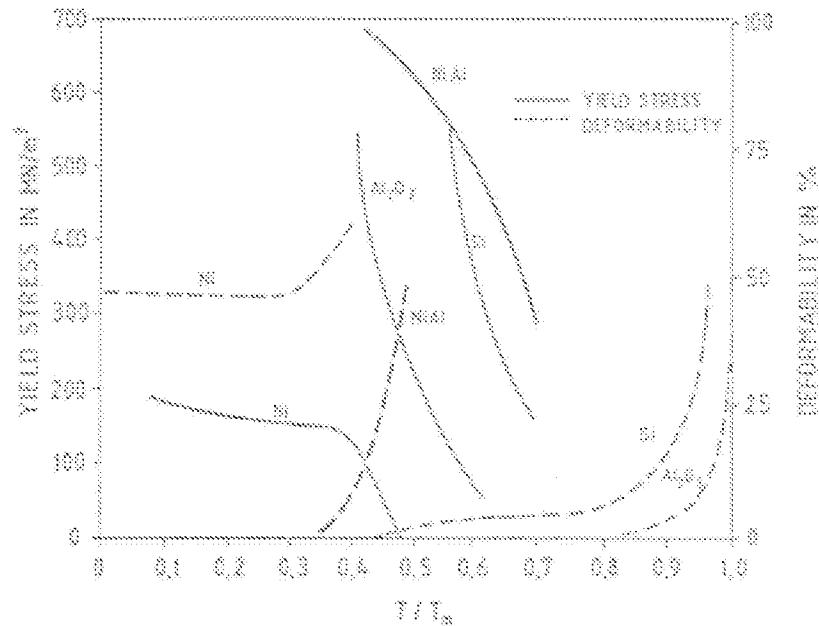
Table 2. Characteristic properties of Ti_3Al , $TiAl$, Ti alloys and superalloys^(a).

	Ti alloys	Ti_3Al	$TiAl$	super- alloys
density (Mg/m ³)	4.5	4.15-4.7	3.76	8.3
Young's modulus (GN/m ²)	110-96	145-110	176	208
max. temp. (°C)				
creep	540	815	1040	1090
oxidation	590	650	1040	1090
ductility (%)				
room temperature	~ 20	2-5	1-2	3-5
service	high	5-8	7-12	10-20

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ameter of high length λ to space dimension of n in the case of cermet. With this condition, it is a low density

intermetallic $NiAl$ which is a candidate phase for high-temperature applications softens with rising temperature at about half the melting point



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The benefits, as well as challenges associated with working with intermetallics are also appreciated by those skilled in the art as described in Non-Patent Literature Cite No. 3, MATERIALS - INTERMETALLIC, in which the following is disclosed:

MATERIALS

Intermetallics

Anthony F. Giamel, FASM (1977)

Intermetallic compounds and alloys have great potential in structural engineering applications, especially at high temperatures. Among the characteristics that make intermetallics so interesting is oxidation resistance at temperatures exceeding 1,100°C (2,000°F). Unfortunately, they also have some serious limitations.

Consequently, through the 1990s, researchers will be seeking ways to improve certain intermetallic properties, especially high-temperature characteristics including ductility

large Burger's vector, or a low solubility of interstitial or trace elements, leading to immobile dislocations or the formation of embrittled grain boundaries.

Recent work shows that intermetallic materials behave at much higher temperatures in creep than the activation energy for creep is close to the energy for self-diffusion. Also, creep strength should be considered on a density-corrected basis. These characteristics make some of the intermetallics exciting candidates for future high-temperature structural use.



Overall, intermetallic compounds have two related problems: brittleness and low cleavage stress. The same strong bonding that makes the materials ordered and strong makes them brittle. Low ductility at low-to-intermediate

The well known characteristics of intermetallics are further described in Non-Patent Literature Cite No. 4, THE PROMISE OF INTERMETALLIC, in which the following is disclosed:

The Promise of Intermetallics

Intermetallics offer the high strength at high temperatures, low density, and high stiffness required for the National Aerospace Plane, interstellar travel, improved diesel engines, and processing equipment for the oil, coal, and chemical industries.

Margaret Hunt
Associate Editor

Intermetallic compounds are well known as constituents of superalloys. Nickel-based superalloys derive much of their high-temperature strength from nickel aluminides and nickel sil-

high stiffness, low density, and high resistance to oxidation and sulfidation.

However,

Intermetallics

Most pure metals have crystal structures such as face centered cubic (fcc), body centered cubic (bcc), or hexagonal close-packed (hcp). In fcc structures, for example, an atom occupies each corner of the cubic structure and the center of each face.

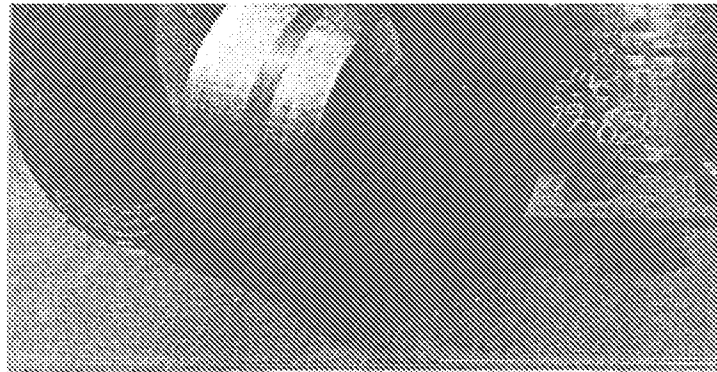
As alloying metals with atoms of similar size are added, they randomly replace the original atoms. For example, as aluminum atoms are added to iron nickel, they may occupy either corners or face positions.

In some alloys, as the alloying additions reach a critical number of atoms, they begin to occupy specific positions. For example,

the nickel atoms occupy the corners of the cubic structure, and the aluminum atoms occupy the face positions. This ordered structure is maintained throughout the bulk of the material.

The reason for this order is the requirement for the nearest neighbor of each aluminum to be a nickel atom results in the ordered structure. Because this order is maintained throughout the bulk of the material,

the material is stronger and harder than the original metal.



but three predominate. First, flow stress can be higher than cleavage stress in the slip planes. For example, the pressure required to cause one cube to slide past another can be higher than that required to break the bonds between the cubes.

Second, some lattice structures are as large and complicated that they cannot deform without breaking. Alloying additions have helped in some cases where the original lattice is modified to a more ductile structure. For example, Co₃V has a brittle hcp structure. Iron in large amounts (up to 30 at.%) was added by researchers at Oak Ridge National Laboratory, Oak Ridge, TN, and the structure changed to fcc with room temperature elongation of 40%. With small

additions of aluminum for oxidation resistance, this intermetallic has the potential for use as high-temperature material.

Third, alloying additions have been successful in modifying the grain structure of the material. Micro-alloying additions that segregate to grain boundaries and strengthen them have been successful in some cases. For example, researchers at Oak Ridge found that boron additions of 100 to 1000 ppm raise tensile elongation of Ni₃Al from essentially nothing to as high as 55%.

Titanium Aluminides for Aerospace

Aluminum is attractive as an intermetallic alloying element because it has low density, and because it forms tenacious coatings of aluminum oxide that provide protection at high temperatures. Aluminides of titanium may be useful for skin and structural components of the National Aerospace Plane (NASP) and other aerospace applications because of their low density and high-temperature capability. They include alpha titanium (Ti₃Al), gamma (TiAl), and several compounds that are variations of these compounds. For example, alpha-2 Ti₃Al has a general composition Ti-1.8Al-21Nb, with niobium added to improve ductility and fracture toughness. Super

Alloy	Crystal structure (ordered)	Melting point (°F)	Density (g/cm ³)	Young's modulus (10 ⁶ psi)
Ni ₃ Al	face-centered cubic	2538	7.80	23.9
Co ₃ Al	body-centered cubic	2886	8.84	42.7
Fe ₃ Al	body-centered cubic	2080	7.77	28.4
FeAl	body-centered cubic	2230	7.26	37.8
Ti ₃ Al	hexagonal close-packed	2919	4.20	21.0
TiAl	tetragonal	2660	3.81	28.8
Ni ₃ Al ₂	orthorhombic	3100	8.28	44.0

Data courtesy Oak Ridge National Laboratory and David Williams.

In view of the disclosures of the included documents and the discussion above, it is readily apparent that the Office's abbreviated definition of *intermetallic* as being "composed of two or more metals or of a metal and non-metal" is not the definition that is applied by those persons skilled in the relevant art; further, the oversimplification at paragraph 9 of the Action dated 15 September 2006 is inaccurate - - the term "intermetallic" connotes far more than merely being "two or more metals" as defined and explained hereinabove.

Applicants reserve the right to establish the patentability of the claimed invention over any of the information provided herewith, and/or to prove that this information may not be prior art, and/or to prove that this information may not be enabling for the teachings purportedly offered.

The filing of this information disclosure statement shall not be construed as a representation that a search has been made, or an admission that the information cited is, or is considered to be, material to patentability, or that the information is analogous to the subject matter of the present invention, or that no other material information exists. Further, the filing of this information disclosure statement shall not be construed as an admission against interest in any manner. Written notification that the enclosed references have been considered in their entirety by return of a copy of the enclosed form, completed by the Examiner, is respectfully requested.

This Information Disclosure Statement is being submitted after the mailing of a non-final Office Action, but is believed to be prior to a final Office Action or a Notice of Allowance. Pursuant to 37 C.F.R. § 1.97(c)(2), the \$180.00 fee is being paid herewith. In the event any variance exists between the amount enclosed and the Patent Office charges, please charge or credit any difference to the undersigned's Deposit Account No. 14-1437.

In order to facilitate the resolution of any issues or questions presented by this paper, the Examiner may directly contact the undersigned by phone to further the discussion.

Respectfully submitted,

A handwritten signature in dark ink, appearing to read "Tracy W. Druce". The signature is fluid and cursive, with the first name "Tracy" and last name "Druce" clearly distinguishable.

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